

# **Device Modeling Report**

COMPONENTS:THYRISTOR  
PART NUMBER:MCR22-3  
MANUFACTURER: MOTOROLA SEMICONDUCTOR



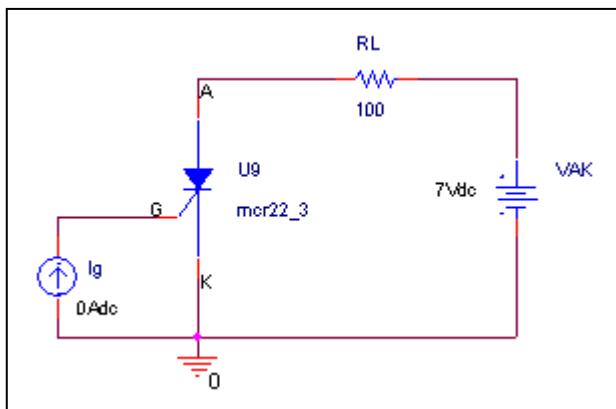
**Bee Technologies Inc.**

## DIODE MODEL

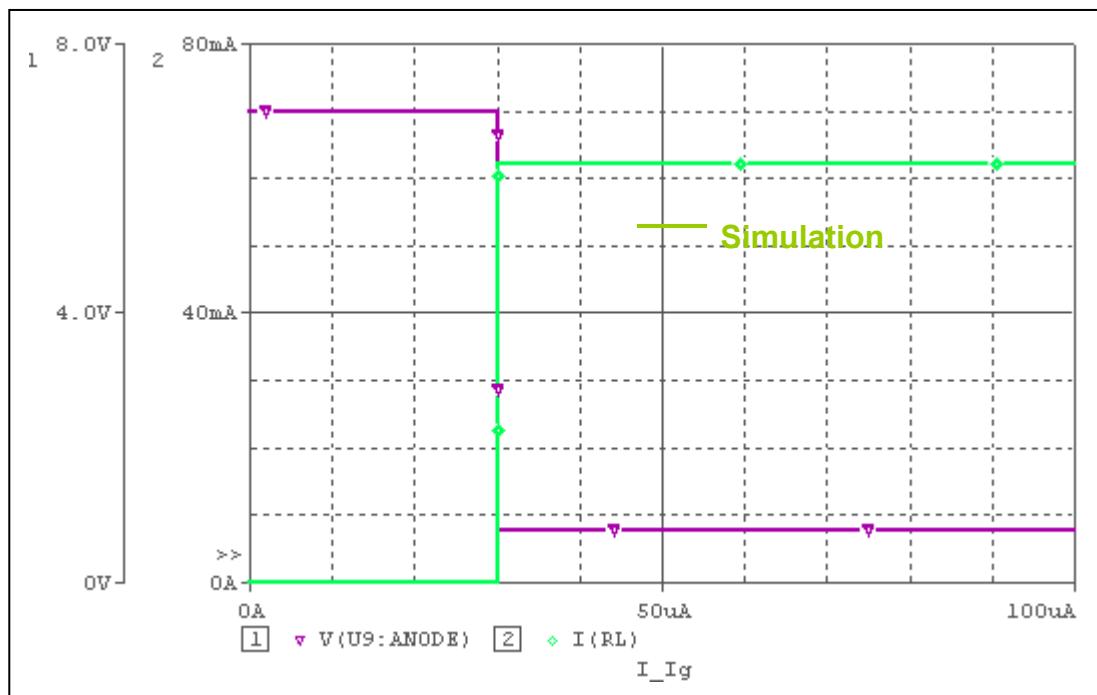
Pspice model Parameter	Model description
IS	Saturation Current
N	Emission Coefficient
RS	Series Resistance
IKF	High-injection Knee Current
CJO	Zero-bias Junction Capacitance
M	Junction Grading Coefficient
VJ	Junction Potential
ISR	Recombination Current Saturation Value
BV	Reverse Breakdown Voltage(a positive value)
IBV	Reverse Breakdown Current(a positive value)
TT	Transit Time

## IG-VT Characteristic

Evaluation Circuit



Simulation result

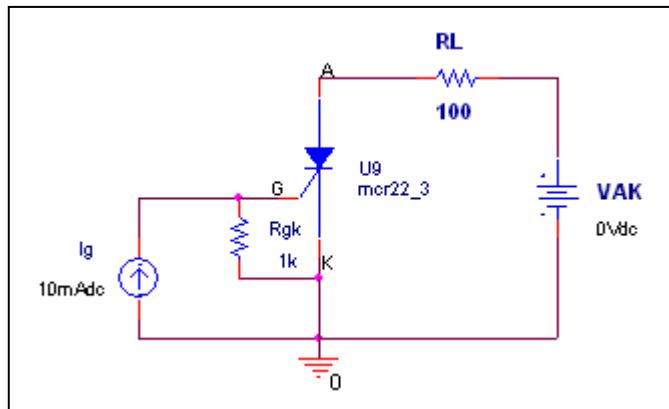


Comparison Table

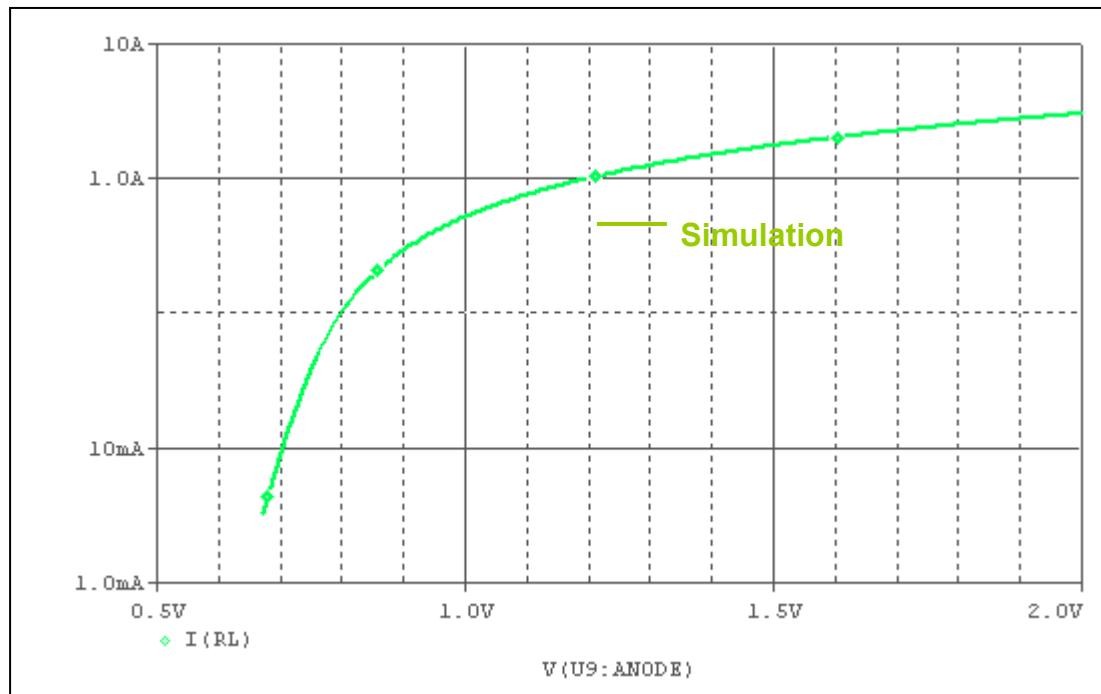
	Measurement	Simulation	% Error
I <sub>GT</sub> ( uA)	30	30	0
V <sub>GT</sub> (V)	0.8(max)	0.771116	-3.61050

## ITM-VM Characteristic

Evaluation Circuit



Simulation result

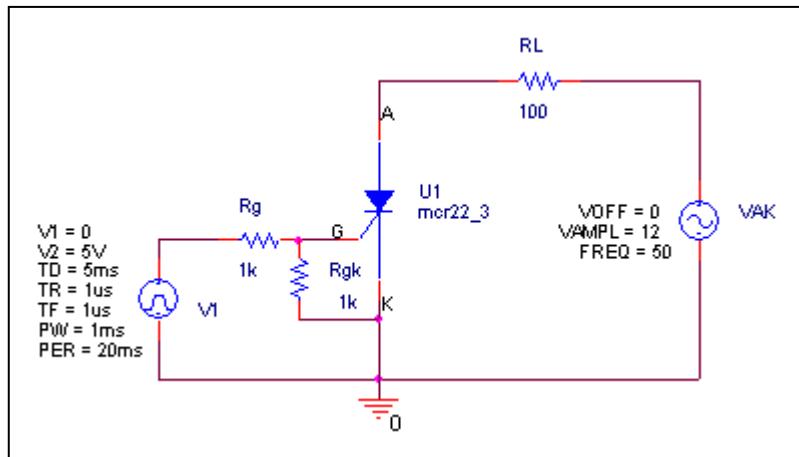


Comparison Table

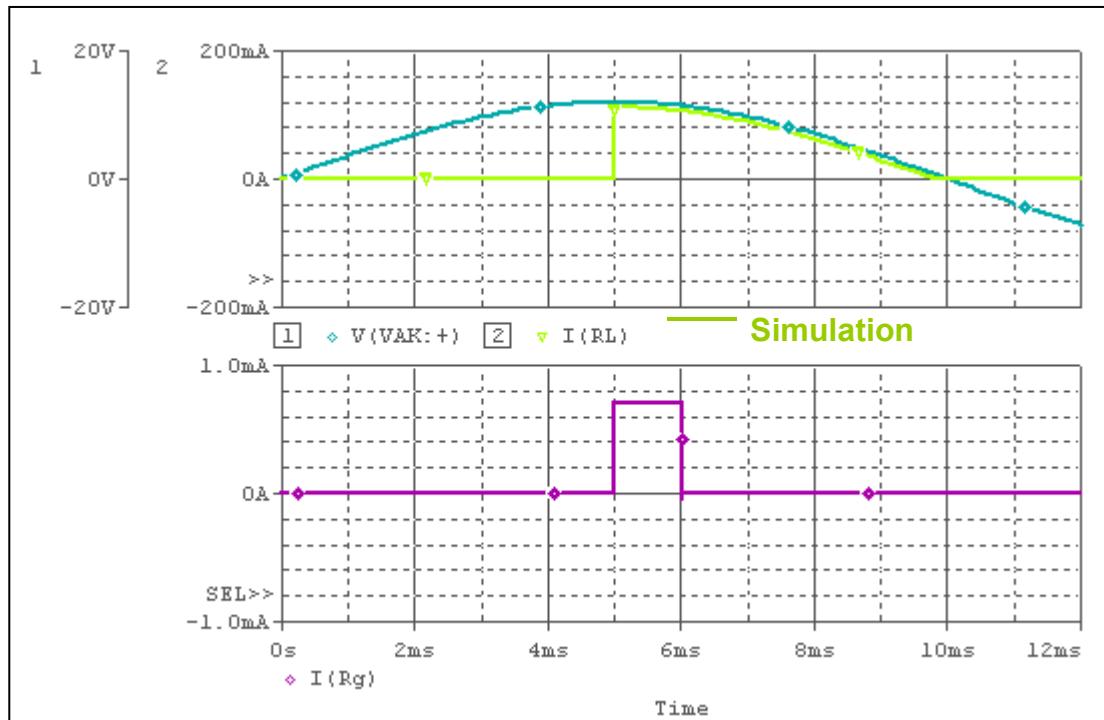
At ITM=1A	Measurement	Simulation	% Error
VTM(V)	1.2	1.2013	0.10833

## Holding Characteristic (IH)

Evaluation Circuit



Simulation result



Comparison Table

VAK=12V	Measurement	Simulation	% Error
IH(mA)	2	2.0432	2.16000